

FEATURES

- High Output Power: P1dB=39.5dBm(Typ.)
- High Gain: G1dB=9.0dB(Typ.)
- High PAE: η_{add} =35%(Typ.)
- Broad Band: 5.85 to 6.75GHz
- Impedance Matched Zin/Zout = 50ohm
- Hermetically Sealed Package



DESCRIPTION

The FLM5964-8F/001 is a power GaAs FET that is internally matched for standard communication bands to provide optimum power and gain in a 50ohm system.

ABSOLUTE MAXIMUM RATINGS

| Item | Symbol | Rating | Unit |
|-----------------------------------|------------------|-------------|-------|
| Drain-Source Voltage (Tc=25deg.C) | V _{DS} | 15 | V |
| Gate-Source Voltage (Tc=25deg.C) | V _{GS} | -5 | V |
| Total Power Dissipation | P _T | 42.8 | W |
| Storage Temperature | T _{stg} | -65 to +175 | deg.C |
| Channel Temperature | T _{ch} | +175 | deg.C |

RECOMMENDED OPERATING CONDITION

| Item | Symbol | Condition | Recommend | Unit |
|----------------------|------------------|-------------------------|-------------|-------|
| DC Input Voltage | V _{DS} | | ≤10 | V |
| Forward Gate Current | I _{GF} | R _G =100 ohm | ≤+32.0 | mA |
| Reverse Gate Current | I _{GR} | R _G =100 ohm | ≥-4.4 | mA |
| Storage Temperature | T _{stg} | | -55 to +125 | deg.C |
| Channel Temperature | T _{ch} | | ≤+155 | deg.C |

ELECTRICAL CHARACTERISTICS (Case Temperature Tc=25deg.C)

| Item | Symbol | Condition | Limit | | | Unit |
|--------------------------------------|------------------|---|-------|------|------|---------|
| | | | Min. | Typ. | Max. | |
| Drain Current | I _{DSS} | V _{DS} =-5V, V _{GS} =0V | - | 3.4 | 5.2 | A |
| Trans conductance | g _m | V _{DS} =-5V, I _{DSS} =2.2A | - | 3.4 | - | S |
| Pinch-off Voltage | V _p | V _{DS} =-5V, I _{DSS} =170mA | -0.5 | -1.5 | -3.0 | V |
| Gate-Source Breakdown Voltage | V _{GSO} | I _{GS} =-170uA | -5.0 | - | - | V |
| Output Power at 1dB G.C.P. | P _{1dB} | V _{DS} =10V f= 5.85 to 6.75 GHz I _{DC} =0.65I _{DSS} (typ.) Z _s =Z _L =50 ohm | 38.5 | 39.5 | - | dBm |
| Power Gain at 1dB G.C.P. | G _{1dB} | | 8.0 | 9.0 | - | dB |
| Drain Current | I _{DSR} | | - | 2.2 | 2.6 | A |
| Power-added Efficiency | η_{add} | | - | 35 | - | % |
| Gain Flatness | ΔG | | - | - | 1.2 | dB |
| 3rd Order Intermodulation Distortion | IM ₃ | f=6.75 GHz Δf =10MHz, 2-tone Test P _{out} =28.5dBm (S.C.L.) | -42 | -45 | - | dBc |
| Thermal Resistance | R _{th} | Channel to Case | - | 3.0 | 3.5 | deg.C/W |
| Channel Temperature Rise | ΔT_{ch} | 10V x I _{DSR} x R _{th} | - | - | 80 | deg.C |

CASE STYLE : IB

S.C.L. : Single Carrier Level

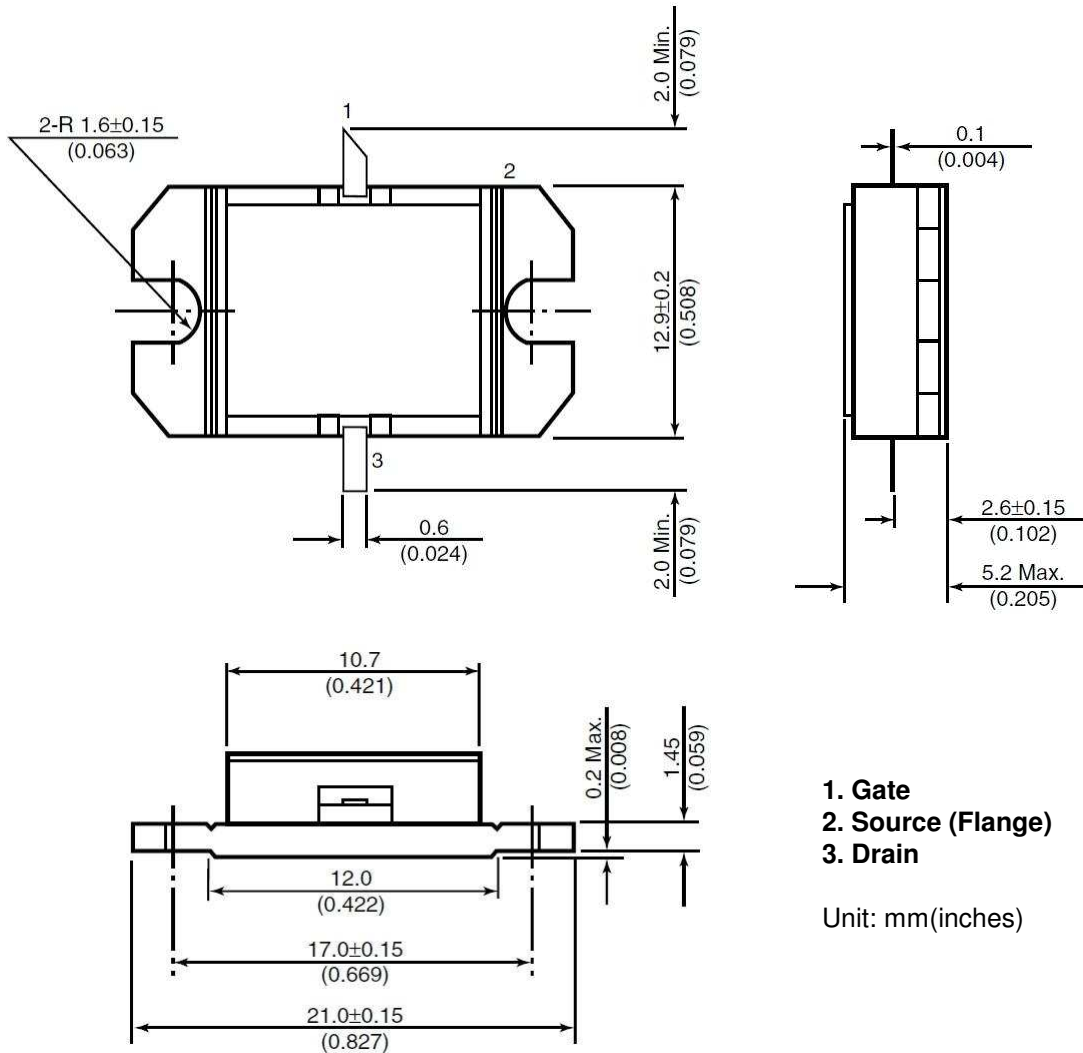
G.C.P.: Gain Compression Point

| | | |
|-----|----------|----------------|
| ESD | Class 3A | 4000V to 8000V |
|-----|----------|----------------|

Note : Based on EIAJ ED-4701 C-111A (C=100pF, R=1.5kohm)

| | |
|-----------------|-----|
| RoHS COMPLIANCE | Yes |
|-----------------|-----|

Case Style "IB"
Metal-Ceramic Hermetic Package





FLM5964-8F/001

C-Band Internally Matched FET

For further information please contact:

<http://global-sei.com/Electro-optic/about/office.html>

CAUTION

This product contains **gallium arsenide (GaAs)** which can be hazardous to the human body and the environment. For safety, observe the following procedures:

- Do not put these products into the mouth.
- Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.
- Observe government laws and company regulations when discarding this product. This product must be discarded in accordance with methods specified by applicable hazardous waste procedures.